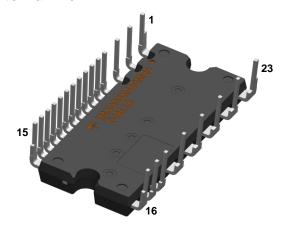
### **External View**



Size: 33.4 x 15 x 3.6 mm



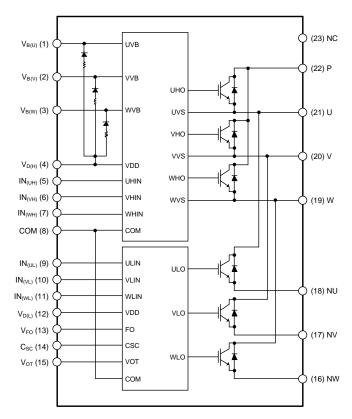
#### **Features**

- UL Recognized: UL1557 File E345245
- 600V-5A (Trench Shielded Planar Gate IGBT)
- 3 phase Inverter module including HVIC drivers
- Built-in bootstrap diodes with integrated current-limiting resistor
- Control supply under-voltage lockout protection (UVLO)
- Over-temperature (OT) protection (V<sub>OT</sub>) pin open
- Temperature monitoring  $(V_{OT}) 10k\Omega$  resistor connection
- Short-circuit current protection (C<sub>SC</sub>)
- Fault out signal (V<sub>FO</sub>) corresponding to SC, UV and OT fault
- Wide input interface (3-18V), Schmitt trigger receiver circuit (Active High)
- Isolation ratings of 2000Vrms/min

## **Applications**

 AC 100-240Vrms class low power motor drives like refrigerator, dishwasher, fan motor, washing machine, and air-conditioner

# **Internal Equivalent Circuit / Pin Configuration**





# **Ordering Information**

| Part Number Temperature Range |                | Package | Pin Length Description |
|-------------------------------|----------------|---------|------------------------|
| AIM5D05K060M2 -40°C to 150°C  |                | IPM-5   | Normal                 |
| AIM5D05K060M2S                | -40°C to 150°C | IPM-5A  | Short                  |



AOS Green Products use reduced levels of Halogens, and are also RoHS compliant. Please visit www.aosmd.com/media/AOSGreenPolicy.pdf for additional information.

# **Pin Description**

| Pin Number | Pin Name           | Pin Function  |  |
|------------|--------------------|---|--|
| 1          | V <sub>B(U)</sub>  | High-Side Bias Voltage for U-Phase IGBT Driving                       |  |
| 2          | $V_{B(V)}$         | High-Side Bias Voltage for V-Phase IGBT Driving                       |  |
| 3          | $V_{B(W)}$         | High-Side Bias Voltage for W-Phase IGBT Driving                       |  |
| 4          | $V_{D(H)}$         | High-Side Common Bias Voltage for IC and IGBTs Driving                |  |
| 5          | IN <sub>(UH)</sub> | Signal Input for High-Side U-Phase                                    |  |
| 6          | IN <sub>(VH)</sub> | Signal Input for High-Side V-Phase                                    |  |
| 7          | IN <sub>(WH)</sub> | Signal Input for High-Side W-Phase                                    |  |
| 8          | COM                | Common Supply Ground  |  |
| 9          | IN <sub>(UL)</sub> | Signal Input for Low-Side U-Phase                                     |  |
| 10         | IN <sub>(VL)</sub> | Signal Input for Low-Side V-Phase                                     |  |
| 11         | IN <sub>(WL)</sub> | Signal Input for Low-Side W-Phase                                     |  |
| 12         | $V_{D(L)}$         | Low-Side Common Bias Voltage for IC and IGBTs Driving                 |  |
| 13         | V <sub>FO</sub>    | Fault Output  |  |
| 14         | C <sub>SC</sub>    | Capacitor (Low-Pass Filter) for Short-circuit Current Detection Input |  |
| 15         | V <sub>OT</sub>    | Voltage Output of LVIC Temperature                                    |  |
| 16         | NW                 | Negative DC-Link Input for W-Phase                                    |  |
| 17         | NV                 | Negative DC-Link Input for V-Phase                                    |  |
| 18         | NU                 | Negative DC-Link Input for U-Phase                                    |  |
| 19         | W                  | Output for W-Phase  |  |
| 20         | V                  | Output for V-Phase  |  |
| 21         | U                  | Output for U-Phase  |  |
| 22         | Р                  | Positive DC-Link Input  |  |
| 23         | NC                 | No Connection   |  |

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# **Absolute Maximum Ratings**

 $T_J = 25$ °C, unless otherwise specified.

| Symbol                 | Parameter  | Conditions  | Ratings             | Units     |
|------------------------|--|---|---------------------|-----------|
| Inverter               |  |   |                     |           |
| $V_{PN}$               | Supply Voltage   | Applied between P - NU,NV,NW  | 450                 | V         |
| V <sub>PN(surge)</sub> | Supply Voltage (surge)   | Applied between P - NU,NV,NW  | 500                 | V         |
| V <sub>CES</sub>       | Collector-Emitter Voltage  |   | 600                 | V         |
|                        | 0 / 151 0 /  | T <sub>C</sub> =25°C, T <sub>J</sub> <150°C   | 5                   | Α         |
| Ic                     | Output Phase Current   | T <sub>C</sub> =100°C, T <sub>J</sub> <150°C  | 3                   | А         |
| ±I <sub>PK</sub>       | Output Peak Phase Current  | T <sub>C</sub> =25°C, less than 1ms pulse width   | 10                  | А         |
| t <sub>SC</sub>        | Short Circuit Withstand Time   | V <sub>PN</sub> ≤400V, T <sub>J</sub> =150°C, V <sub>D</sub> =15V   | 5                   | μs        |
| Pc                     | Collector Dissipation  | T <sub>C</sub> =25°C, per chip  | 18.9                | W         |
| TJ                     | Operating Junction Temperature   |   | -40 to 150          | °C        |
| Control (P             | Protection)  |   |                     | <u> </u>  |
| V <sub>D</sub>         | Control Supply Voltage   | Applied between V <sub>D(H)</sub> -COM, V <sub>D(L)</sub> -COM  | 25                  | V         |
| $V_{DB}$               | High-Side Control Bias Voltage   | Applied between V <sub>B(U)</sub> -U, V <sub>B(V)</sub> -V, V <sub>B(W)</sub> -W  | 25                  | V         |
| V <sub>IN</sub>        | Input Voltage  | Applied between IN <sub>(UH)</sub> , IN <sub>(VH)</sub> , IN <sub>(WH)</sub> , IN <sub>(UL)</sub> , IN <sub>(VL)</sub> , IN <sub>(WL)</sub> - COM | V <sub>D</sub> ±0.5 | V         |
| $V_{FO}$               | Fault Output Supply Voltage  | Applied between V <sub>FO</sub> - COM   | 5±0.5               | V         |
| I <sub>FO</sub>        | Fault Output Current   | Sink current at V <sub>FO</sub> terminal  | 1                   | mA        |
| V <sub>SC</sub>        | Current Sensing Input Voltage  | Applied between C <sub>SC</sub> - COM   | 5±0.5               | V         |
| V <sub>OT</sub>        | Temperature Output   | Applied between V <sub>OT</sub> - COM   | 5±0.5               | V         |
| Total Syst             | em   |   |                     | <u> </u>  |
| V <sub>PN(PROT)</sub>  | Self Protection Supply Voltage Limit (Short-circuit protection capability) | V <sub>D</sub> =13.5-16.5V, Inverter part<br>T <sub>J</sub> =150°C, Non-repetitive, less than 2µs   | 400                 | V         |
| T <sub>C</sub>         | Module Case Operation<br>Temperature                                       | Measurement point of T <sub>C</sub> is provided in Figure 1   | -30 to 125          | °C        |
| T <sub>STG</sub>       | Storage Temperature  |   | -40 to 150          | °C        |
| V <sub>ISO</sub>       | Isolation Voltage  | 60Hz, sinusoidal, AC 1min, between connected all pins and heat sink plate   | 2000                | $V_{rms}$ |

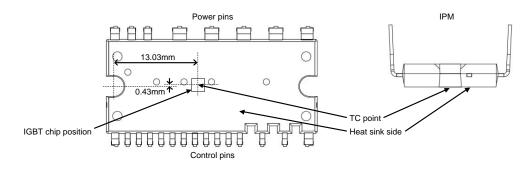


Figure 1. T<sub>C</sub> Measurement Point

### **Thermal Resistance**

| Symbol                | Parameter                               | Parameter Conditions Min.      |   | Тур. | Max. | Units |
|-----------------------|---|--------------------------------|---|------|------|-------|
| R <sub>th(j-c)Q</sub> | lunction to Cook Thornal Basistones (1) | Inverter IGBT (per 1/6 module) | - | -    | 6.6  | K/W   |
| R <sub>th(j-c)F</sub> | Junction to Case Thermal Resistance (1) | Inverter FWD (per 1/6 module)  | - | -    | 8.5  | K/W   |

### Note:

1. For the measurement point of case temperature ( $T_{\text{C}}$ ), please refer to Figure 1.



#### **Electrical Characteristics**

 $T_J = 25$ °C, unless otherwise specified.

| Symbol               | Parameter                                   | Co  | Min.  | Тур. | Max. | Units |    |
|----------------------|---|---|---|------|------|-------|----|
| Inverter             |   |   |   |      |      |       |    |
| .,                   | Collector-Emitter Saturation                | $V_D=V_{DB}=15V$ ,  | I <sub>C</sub> =2.5A, T <sub>J</sub> =25°C  | -    | 1.48 | 1.85  | V  |
| $V_{CE(SAT)}$        | Voltage                                     | V <sub>IN</sub> =5V   | I <sub>C</sub> =2.5A, T <sub>J</sub> =125°C | -    | 1.69 | -     | V  |
| V <sub>F</sub>       | FWD Forward Voltage                         | V <sub>IN</sub> =0  | I <sub>F</sub> =2.5A, T <sub>J</sub> =25°C  | -    | 1.75 | 2.15  | V  |
| t <sub>ON</sub>      |   |   |   |      |      |       | μs |
| t <sub>C(ON)</sub>   | 1   | $V_{PN}=300V, V_{D}=V_{DB}=15V$   |   | -    | 0.10 | 0.40  | μs |
| t <sub>OFF</sub>     | Switching Times                             | $I_C=2.5A$ , $T_J=25$ °C, $V_I$   | <sub>N</sub> =0V ↔ 5V                       | -    | 0.85 | 1.45  | μs |
| t <sub>C(OFF)</sub>  |   | Inductive load (high-   | side)                                       | -    | 0.12 | 0.30  | μs |
| t <sub>rr</sub>      |   |   |   | -    | 0.18 | -     | μs |
|                      | Collector-Emitter Leakage                   | V <sub>CE</sub> =V <sub>CES</sub>   | T <sub>J</sub> =25°C                        | -    | -    | 1     | mA |
| I <sub>CES</sub>     | Current                                     | T <sub>J</sub> =125°C   |   | -    | -    | 10    | mA |
| Control (P           | Protection)                                 |   |   |      |      |       |    |
| I <sub>QDH</sub>     | Quiescent V <sub>D</sub> Supply Current     | V <sub>D(H)</sub> =15V,<br>IN <sub>(UH, VH, WH)</sub> =0V   | V <sub>D(H)</sub> - COM                     | -    | -    | 0.1   | mA |
| $I_{QDL}$            | Quioscent v <sub>0</sub> cupply current     | $V_{D(L)}=15V, \ IN_{(UL, \ VL, \ WL)}=0V$  | V <sub>D(L)</sub> - COM                     | -    | -    | 2.1   | mA |
| $I_{QDB}$            | Quiescent V <sub>DB</sub> Supply<br>Current | $V_{DB}$ =15V, $V_{B(U)}$ -U, $V_{B(V)}$ -V, $V_{B(W)}$ -W  |   | -    | -    | 0.3   | mA |
| V <sub>SC(ref)</sub> | Short-Circuit Trip Level                    | V <sub>D</sub> =15V (2)   | V <sub>D</sub> =15V <sup>(2)</sup>          |      |      | 0.51  | V  |
| tcsc                 | C <sub>SC</sub> Input Filter Time           | V <sub>SC</sub> =1V   |   | -    | 600  | -     | ns |
| $UV_{DT}$            |   | Trip Level  |   | 10.3 | 11.4 | 12.5  | V  |
| $UV_DR$              | Supply Circuit Under-Voltage                | Reset Level   |   | 10.8 | 11.9 | 13.0  | V  |
| UV <sub>DBT</sub>    | Protection                                  | Trip Level  |   | 8.5  | 9.5  | 10.5  | V  |
| $UV_DBR$             |   | Reset Level   |   | 9.5  | 10.5 | 11.5  | V  |
| V                    | Tomporatura Quitnut                         | Pull-down   | LVIC Temperature=80°C                       | 2.36 | 2.45 | 2.55  | V  |
| V <sub>OT</sub>      | Temperature Output                          | R=10kΩ <sup>(3)</sup>   | LVIC Temperature=25°C                       | 0.77 | 1.00 | 1.25  | V  |
| OT <sub>T</sub>      | Over-Temperature                            | V <sub>D</sub> =15V, Detect   | Trip Level                                  | 110  | 130  | 150   | °C |
| OT <sub>HYS</sub>    | Protection (4)                              | LVIC Temperature  | Hysteresis of Trip Reset                    | -    | 30   | -     | °C |
| $V_{FOH}$            | Fault Output Voltage                        | V <sub>SC</sub> =0V, V <sub>FO</sub> Circuit:   | 10kΩ to 5V pull-up                          | 4.9  | -    | -     | V  |
| $V_{FOL}$            |   | V <sub>SC</sub> =1V, V <sub>FO</sub> Circuit:   | 10kΩ to 5V pull-up                          | -    | -    | 0.5   | V  |
| $t_{FO}$             | Fault Output Pulse Width (5)                |   |   | 20   | -    | -     | μs |
| I <sub>IN</sub>      | Input Current                               | V <sub>IN</sub> =5V   |   | -    | 1.0  | -     | mA |
| $V_{th(on)}$         | ON Threshold Voltage                        | Applied between IN <sub>(UH)</sub> , IN <sub>(VH)</sub> , IN <sub>(WH)</sub> , IN <sub>(UL)</sub> , |   |      | 2.3  | 2.6   | V  |
| $V_{\text{th(off)}}$ | OFF Threshold Voltage                       |   |   | 0.8  | 1.2  |       | V  |
| $V_{\text{th(hys)}}$ | ON/OFF Threshold<br>Hysteresis Voltage      | IN <sub>(VL)</sub> , IN <sub>(WL)</sub> – COM   | -   | 1.1  | -    | V     |    |
| V <sub>F(BSD)</sub>  | Bootstrap Diode Forward<br>Voltage          | I <sub>F</sub> =10mA Including \ Resistor (6)   | oltage Drop by Limiting                     | 1.0  | 1.5  | 2.0   | ٧  |
| R <sub>BSD</sub>     | Built-in Limiting Resistance                | Included in Bootstra  | p Diode                                     | 80   | 100  | 120   | Ω  |

#### Notes:

- 2. Short-circuit protection works only for low sides.
- 3. The IPM does not shutdown IGBTs and output fault signal automatically when temperature rises excessively. When temperature exceeds the protective level that the user defined, the controller (MCU) should stop the IPM. Temperature of LVIC vs. V<sub>OT</sub> output characteristics is described in Figure 3.
- 4. When the LVIC temperature exceeds OT Trip temperature level (OT<sub>T</sub>), OT protection is triggered and fault outputs.
- Fault signal (F<sub>o</sub>) outputs when SC, UV or OT protection is triggered. F<sub>o</sub> pulse width is different for each protection mode. At SC failure, F<sub>o</sub> pulse width is a fixed width (minimum 20μs), but at UV or OT failure, F<sub>o</sub> outputs continuously until recovering from UV or OT state. (But minimum F<sub>o</sub> pulse width is 20μs).
- 6. The characteristics of bootstrap diodes are described in Figure 2.

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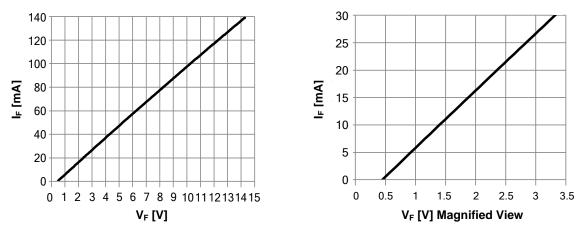


Figure 2. Built-in Bootstrap Diode V<sub>F</sub>-I<sub>F</sub> Characteristic (@T<sub>A</sub>=25°C)

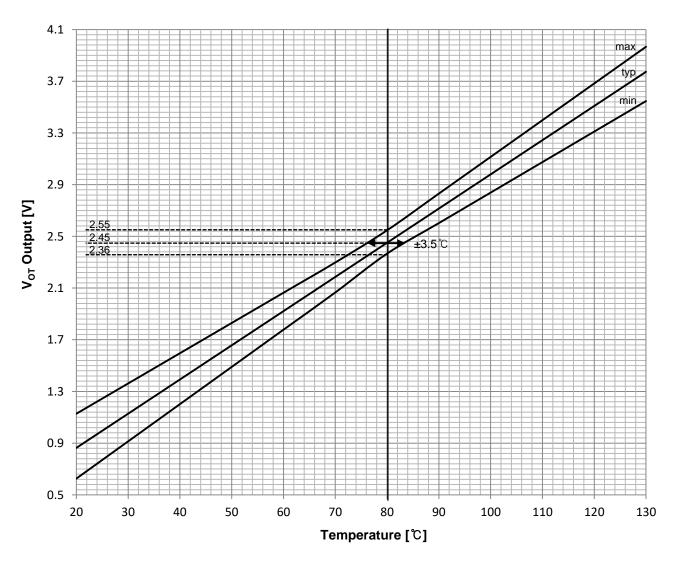


Figure 3. Temperature of LVIC vs. VoT Output Characteristics

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Figure 4. VoT Output Circuit

- (1) Connect  $10k\Omega$  to  $V_{OT}$  pin if temperature monitoring function is utilized; otherwise if the  $V_{OT}$  pin is left unconnected, the internal over-temperature shutdown function is used instead.
- (2) In the case of using V<sub>OT</sub> with low voltage controller like 3.3V MCU, V<sub>OT</sub> output might exceed control supply voltage 3.3V when temperature rises excessively. If system uses low voltage controller, it is recommended to insert a clamp diode between control supply of the controller and V<sub>OT</sub> output for preventing over voltage destruction.

## **Mechanical Characteristics and Ratings**

| Symbol          | Parameter              | Conditions | Min. | Тур. | Max. | Units |
|-----------------|------------------------|------------|------|------|------|-------|
| Mounting torque | Mounting Screw: M3 (7) |            | 0.59 | 0.69 | 0.78 | N m   |
| Weight          |                        |            | -    | 5.25 | -    | g     |
| Flatness        | Refer to Figure 5      |            | -50  | -    | 100  | μm    |

#### Note:

7. Plain washers (ISO 7089-7094) are recommended.

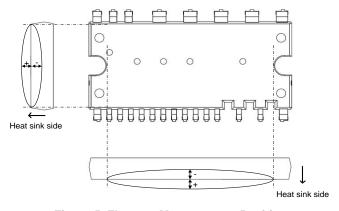


Figure 5. Flatness Measurement Positions

**Recommended Operation Conditions** 

| Symbol                                       | Parameter                       | Conditions  | Min. | Тур. | Max. | Units |
|--|---------------------------------|---|------|------|------|-------|
| V <sub>PN</sub>                              | Supply Voltage                  | Applied between P-NU, NV, NW                                | 0    | 300  | 400  | V     |
| $V_D$  | Control Supply Voltage          | Applied between $V_{D(H)}$ – COM, $V_{D(L)}$ - COM          | 13.5 | 15.0 | 16.5 | V     |
| $V_{DB}$                                     | High-Side Bias Voltage          | Applied between $V_{B(U)}$ -U, $V_{B(V)}$ -V, $V_{B(W)}$ -W | 13.5 | 15.0 | 18.5 | V     |
| dV <sub>D</sub> /dt,<br>dV <sub>DB</sub> /dt | Control Supply Variation        |   | -1   | -    | 1    | V/µs  |
| t <sub>dead</sub>                            | Arm Shoot-Through Blocking Time | For each input signal                                       | 1.0  | -    | -    | μs    |
| f <sub>PWM</sub>                             | PWM Input Frequency             | -40°C < T <sub>J</sub> < 150°C                              | -    | -    | 20   | kHz   |
| PW <sub>IN(ON)</sub>                         | Minimum Indust Dula Middle (8)  |   | 0.5  | -    | -    | μs    |
| PW <sub>IN(OFF)</sub>                        | Minimum Input Pulse Width (8)   |   | 0.5  | -    | -    | μs    |
| СОМ  | COM Variation                   | Between COM - NU, NV, NW (including surge)                  | -5.0 | -    | 5.0  | V     |

#### Note:

8. IPM may not respond if the input pulse width is less than  $PW_{IN(OFF)}$ .

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### **Time Charts of the IPM Protective Function**

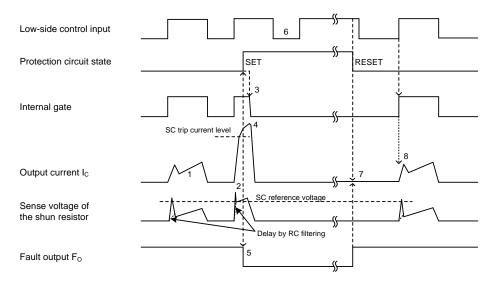


Figure 6. Short-Circuit Protection (Low-side Operation Only with the External Shunt Resistor and RC Filter)

- (1) Normal operation: IGBT turns on and outputs current.
- (2) Short-circuit current detection (SC triggered).
- (3) All low-side IGBTs' gates are hard interrupted.
- (4) All low-side IGBTs turn OFF.
- (5)  $F_O$  output time ( $t_{FO}$ )=minimum 20 $\mu$ s.
- (6) Input = "L" : IGBT OFF.
- (7) Fault output finishes, but output current will not turn on until next ON signal ( $L\rightarrow H$ ).
- (8) Normal operation: IGBT turns on and outputs current.

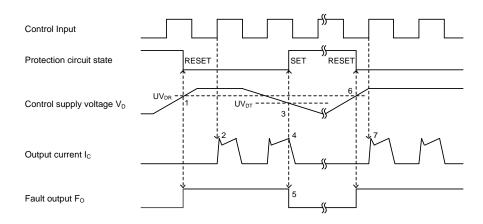


Figure 7. Under-Voltage Protection (Low-side, UV<sub>D</sub>)

- (1) Control supply voltage V<sub>D</sub> exceeds under voltage reset level (UV<sub>DR</sub>), but IGBT turns on by next ON signal (L→H).
- (2) Normal operation: IGBT turns on and outputs current.
- (3) V<sub>D</sub> level drops to under voltage trip level (UV<sub>DT</sub>).
- (4) All low-side IGBTs turn OFF regardless of control input condition.
- (5)  $F_O$  output time ( $t_{FO}$ )=minimum 20 $\mu$ s, and  $F_O$  stays low as long as  $V_D$  is below  $UV_{DR}$ .
- (6) V<sub>D</sub> level reaches UV<sub>DR</sub>.
- (7) Normal operation: IGBT turns on and outputs current.

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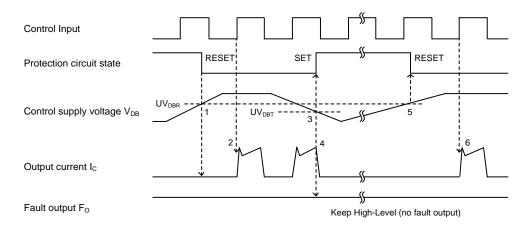


Figure 8. Under-Voltage Protection (High-side, UVDB)

- Control supply voltage V<sub>DB</sub> rises. After the voltage reaches under voltage reset level UV<sub>DBR</sub>, IGBT turns on by next ON signal (L→H).
- (2) Normal operation: IGBT turns on and outputs current.
- (3)  $V_{DB}$  level drops to under voltage trip level (UV<sub>DBT</sub>).
- (4) All high-side IGBTs turn OFF regardless of control input condition, but there is no Fo signal output.
- (5) V<sub>DB</sub> level reaches UV<sub>DBR</sub>.
- (6) Normal operation: IGBT turns on and outputs current.

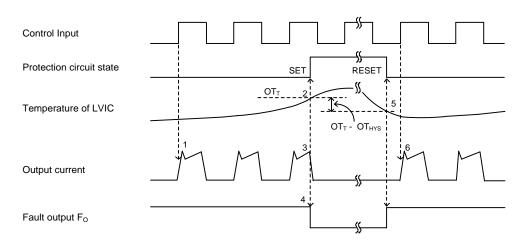


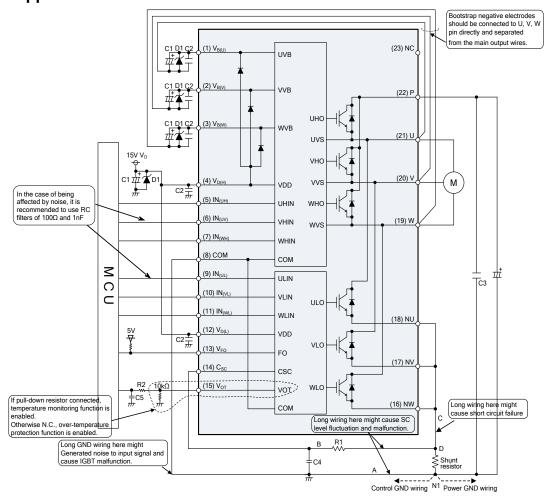
Figure 9. Over-Temperature Protection (Low-side, Detecting LVIC Temperature)

- (1) Normal operation: IGBT turns on and outputs current.
- (2) LVIC temperature exceeds over-temperature trip level (OT<sub>T</sub>).
- (3) All low-side IGBTs turn off regardless of control input condition.
- (4)  $F_O$  output time ( $t_{FO}$ )=minimum 20 $\mu$ s, and  $F_O$  stays low as long as LVIC temperature is over  $OT_T$ .
- (5) LVIC temperature drops to over-temperature reset level ( $OT_T$ - $OT_{HYS}$ ).
- (6) Normal operation: IGBT turns on by the next ON signal (L $\rightarrow$ H).

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### **Example of Application Circuit**



- (1) If the control GND is connected with the power GND by common broad pattern, it may cause malfunction by power GND fluctuation. It is recommended to connect the control GND and power GND at a single point (N1), near the terminal of the shunt resistor.
- (2) A zener diode D1 (24V/1W) is recommended between each pair of control supply pins to prevent surge destruction.
- (3) Prevention of surge destruction can further be improved by placing the bus capacitor as close to pin P and N1 as possible. Generally a 0.1-0.22µF snubber capacitor C3 between the P-N1 terminals is recommended.
- (4) Selection of the R1\*C4 filter components for short-circuit protection is recommended to have tight tolerance, and is temperature-compensated type. The R1\*C4 time constant should be set such that SC current is shut down within 2µs; (typically 1.5-2µs). R1 and C4 should be placed as close as possible to the C<sub>SC</sub> pin. SC interrupting time may vary with layout patterns and components selection, therefore thorough evaluation in the system is necessary.
- (5) Tight tolerance and temperature-compensated components are also recommended when selecting the R2\*C5 filter for V<sub>OT</sub>. The R2\*C5 time constant should be set such that V<sub>OT</sub> is immune to noise. Recommended values of R2 and C5 are 2kΩ and 10nF.
- (6) To prevent malfunction, traces A, B, and C should be as short as possible.
- (7) It is recommended that all capacitors are mounted as close to the IPM as possible. (C1: electrolytic type with good temperature and frequency characteristics. C2: ceramic type with 0.1-2µF, good temperature, frequency and DC bias characteristics.)
- (8) Input drives are active-high. There is a minimum 3.5kΩ pull-down resistor in the input circuit of IC. To prevent malfunction, the layout to each input should be as short as possible. When using RC coupling circuit, make sure the input signal levels meet the required turn-on and turn-off threshold voltages.
- (9) V<sub>FO</sub> output is open drain type. It should be pulled up to MCU or control power supply (max= 5±0.5V), limiting the current (I<sub>FO</sub>) to no more than 1mA. I<sub>FO</sub> is estimated roughly by the formula of control power supply voltage divided by pull-up resistor. For example, if control supply is 5V, a 10kΩ (over 5kΩ) pull-up resistor is recommended.
- (10) Direct drive of the IPM from the MCU is possible without having to use opto-coupler or isolation transformer.
- (11) The IPM may malfunction and erroneous operations may occur if high frequency noise is superimposed to the supply line. To avoid such problems, line ripple voltage is recommended to have dV/dt ≤ ±1V/μs, and Vripple ≤2Vp-p.
- (12) It is not recommended to use the IPM to drive the same load in parallel with another IPM or inverter types.



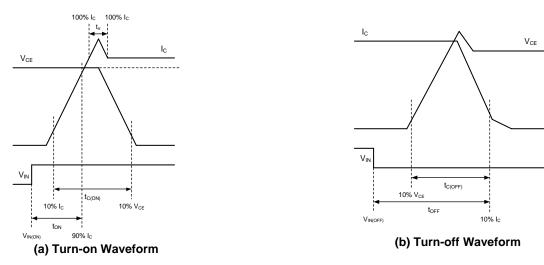
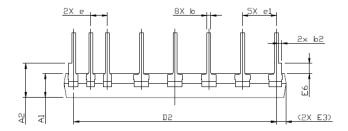


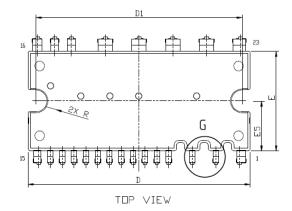
Figure 10. Switching Times Definition

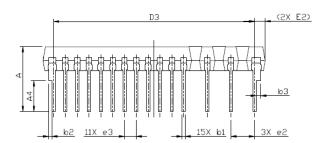
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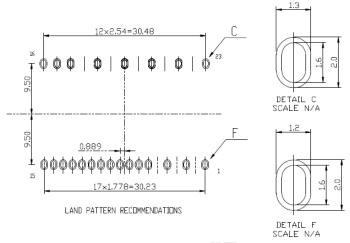


# Package Dimensions, IPM-5







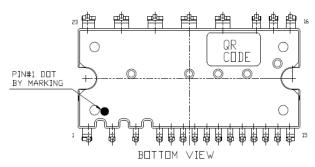


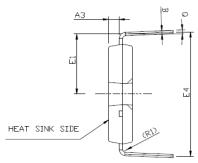
UNIT: mm

NOTE
A) PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
MOLD FLASH SHOULD BE LESS THAN 6 MIL.
B) TOLERANCE 0.100 MILLIMETERS UNLESS OTHERWISE SPECIFIED.
C) CONTROLLING DIMENSION IS MILLIMETER.

CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.

D) ( ) IS REFERENCE





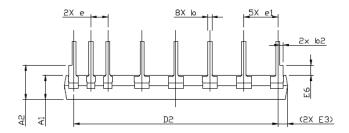


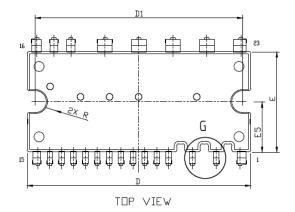
DETAIL G SCALE 5 : 1

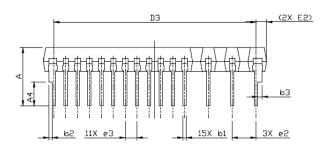
|         | DIMENSI            | ONS IN MILI | _IMETERS | DIMENS | IONS IN INC | HES   |  |
|---------|--------------------|-------------|----------|--------|-------------|-------|--|
| SYMBOLS | MIN                | NDM         | MAX      | MIN    | NDM         | MAX   |  |
| Α       | 9.30               | 9.70        | 10.10    | 0.366  | 0.382       | 0.398 |  |
| A1      | 3.30               | 3.60        | 3.90     | 0.130  | 0.142       | 0.154 |  |
| A2      | 4.70               | 5.10        | 5.50     | 0.185  | 0.201       | 0.217 |  |
| А3      | 1.50               | 1.60        | 1.70     | 0.059  | 0.063       | 0.067 |  |
| A4      | 4.20               | 4.60        | 5.00     | 0.165  | 0.181       | 0.197 |  |
| В       | 0.40               | 0.50        | 0.60     | 0.016  | 0.020       | 0.024 |  |
| b       | 0.50               | 0.60        | 0.70     | 0.020  | 0.024       | 0.028 |  |
| b1      | 0,40               | 0,50        | 0,60     | 0,016  | 0.020       | 0,024 |  |
| b2      | 0.40               | 0.50        | 0.60     | 0.016  | 0.020       | 0.024 |  |
| k3      | 0.60               | 0.70        | 0.80     | 0.024  | 0.028       | 0.032 |  |
| D       | 33,10              | 33.40       | 33.70    | 1.303  | 1.315       | 1,327 |  |
| D1      | 30.80              | 31.00       | 31.20    | 1.213  | 1.220       | 1.228 |  |
| D2      | 30.18              | 30,48       | 30,78    | 1,188  | 1,200       | 1,212 |  |
| D3      | 29.93              | 30.23       | 30.53    | 1.178  | 1.190       | 1,202 |  |
| E       | 14.70              | 15,00       | 15,30    | 0.579  | 0.591       | 0.602 |  |
| E1      | 8.60               | 9.00        | 9,40     | 0,339  | 0,354       | 0,370 |  |
| E2      | 1.60 REF           |             |          |        | .063 REF    | •     |  |
| E3      | 1.5                | 0 REF       |          | 0.     | .059 REF    | •     |  |
| E4      | 18,30              | 18,70       | 19,10    | 0.720  | 0.736       | 0,752 |  |
| E5      | 7.30               | 7.50        | 7.70     | 0.287  | 0.295       | 0.303 |  |
| E6      | 1.10               | 1,50        | 1,90     | 0.043  | 0.059       | 0.075 |  |
| е       | 2.34               | 2.54        | 2.74     | 0.092  | 0.010       | 0.108 |  |
| e1      | 4.88               | 5.08        | 5.28     | 0.192  | 0.200       | 0.208 |  |
| e2      | 3.356              | 3,556       | 3.756    | 0.132  | 0.140       | 0.148 |  |
| е3      | 1.578              | 1.778       | 1.978    | 0.062  | 0.070       | 0.078 |  |
| R       | 1.50               | 1.60        | 1.70     | 0.059  | 0.063       | 0.067 |  |
| R1      | 0.40 REF 0.016 REF |             |          |        |             |       |  |
| 0       |                    | 26.         |          | 20-60  |             |       |  |

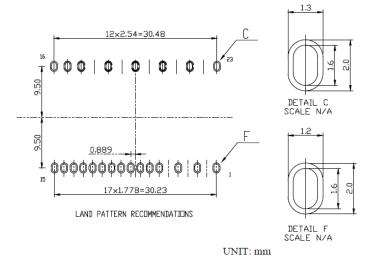


# Package Dimensions, IPM-5A



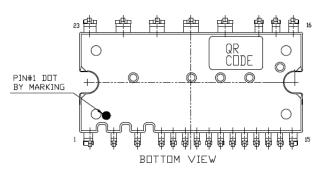


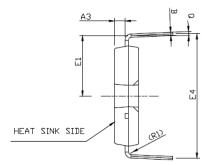




- NOTE
  A) PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
  MOLD FLASH SHOULD BE LESS THAN 6 MIL.
  B) TOLERANCE 0.100 MILLIMETERS UNLESS OTHERWISE SPECIFIED.
  C) CONTROLLING DIMENSION IS MILLIMETER.

- CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT. D) ( ) IS FOR REFERENCE







DETAIL G SCALE 5 : 1

| 0,44851.0 | DIMENSIONS IN MILLIMETERS DIMENSIONS IN IN |       |          | IDNS IN INC | HES      |       |
|-----------|--|-------|----------|-------------|----------|-------|
| SYMBOLS   | MIN  | NDM   | MAX      | MIN         | NDM      | MAX   |
| Α         | 8.30                                       | 8.70  | 9.10     | 0.326       | 0.342    | 0.358 |
| A1        | 3,30                                       | 3.60  | 3.90     | 0.130       | 0.142    | 0.154 |
| A2        | 4.70                                       | 5.10  | 5.50     | 0.185       | 0.201    | 0.217 |
| A3        | 1.50                                       | 1.60  | 1.70     | 0.059       | 0.063    | 0.067 |
| Α4        | 3.20                                       | 3.60  | 4.00     | 0.125       | 0.141    | 0.157 |
| В         | 0.40                                       | 0.50  | 0.60     | 0.016       | 0.020    | 0.024 |
| b         | 0.50                                       | 0.60  | 0.70     | 0.020       | 0.024    | 0.028 |
| b1        | 0.40                                       | 0.50  | 0.60     | 0.016       | 0.020    | 0.024 |
| b2        | 0.40                                       | 0.50  | 0.60     | 0.016       | 0.020    | 0.024 |
| b3        | 0.60                                       | 0.70  | 0.80     | 0.024       | 0.028    | 0.032 |
| D         | 33.10                                      | 33.40 | 33.70    | 1.303       | 1.315    | 1.327 |
| D1        | 30,80                                      | 31,00 | 31,20    | 1,213       | 1,220    | 1,228 |
| DS.       | 30,18                                      | 30,48 | 30.78    | 1.188       | 1,200    | 1.212 |
| D3        | 29.93                                      | 30,23 | 30.53    | 1.178       | 1.190    | 1,202 |
| E         | 14.70                                      | 15.00 | 15.30    | 0.579       | 0.591    | 0.602 |
| E1        | 8.60                                       | 9.00  | 9.40     | 0.339       | 0.354    | 0.370 |
| E2        | 1.60 REF                                   |       |          | 0.          | .063 REF |       |
| E3        | 1.5  | 0 REF |          | 0.          | .059 REF |       |
| E4        | 18.20                                      | 18.60 | 19.00    | 0.716       | 0.732    | 0.748 |
| E5        | 7.30                                       | 7.50  | 7.70     | 0.287       | 0.295    | 0'303 |
| E6        | 1.10                                       | 1.50  | 1.90     | 0.043       | 0.059    | 0.075 |
| е         | 2.34                                       | 2,54  | 2.74     | 0.092       | 0.010    | 0.108 |
| e1        | 4.88                                       | 5.08  | 5.<br>5. | 0.192       | 0,200    | 0.208 |
| e2        | 3,356                                      | 3,556 | 3,756    | 0.132       | 0.140    | 0.148 |
| е3        | 1.578                                      | 1.778 | 1.978    | 0.062       | 0.070    | 0.078 |
| R         | 1.50                                       | 1.60  | 1.70     | 0.059       | 0.063    | 0.067 |
| R1        | 0.40 REF                                   |       |          | 0.016 REF   |          |       |
| Q         |  | 2°-6° |          | 2°-6°       |          |       |



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- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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